

# General Description

The KSE6009 uses advanced trench technology to provide excellent R<sub>DS</sub>(ON), low gate charge and operation with gate voltages as low as1.8V. This device is suitable for use as a load switch or in PWM applications

# **Product Summary**

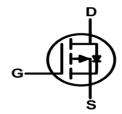
V <sub>DS</sub> (V)	$R_{DS(on)}$ (m $\Omega$ )	I <sub>D</sub> (A)
-60	140 at VGS = 10 V	-2.5
	176 at VGS = 4.5 V	-1.8

#### Features

- High power and current handing capability
- Lead free product is acquired
- Surface mount package

# **SOT-89** Pin Configuration





# **Applications**

- Load switch Power
- management

# Absolute Maximum Ratings Tc=25°C unless otherwise noted

Symbol	Parameter	Rating	Units
V <sub>DS</sub>	Drain-Source Voltage	-60	V
V <sub>G</sub> s	Gate-Source Voltage	±20	V
	Drain Current – Continuous (Tc=25℃)	-2.5	А
D	Drain Current – Continuous (Tc=100℃)	-1.8	А
рм	Drain Current – Pulsed¹	-11	А
P <sub>D</sub>	Power Dissipation (T <sub>C</sub> =25℃)	0.8	W
	Power Dissipation (Tc=100°C)	0.01	W/°C
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C
Гл	Operating Junction Temperature Range	-55 to 150	℃

#### Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient		70	°C/W
Rejc	Thermal Resistance Junction to Case		16	°C/W



# Electrical Characteristics ( $T_J$ =25 °C, unless otherwise noted) Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	-60			V
,	Drain-Source Leakage Current	V <sub>DS</sub> =-60V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			1	uA
IDSS		V <sub>DS</sub> =-60V , V <sub>GS</sub> =0V , T <sub>J</sub> =125℃			10	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> =±20V , V <sub>DS</sub> =0V			±100	nA

#### On Characteristics

R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> =-10V , I <sub>D</sub> =-2.5A		132	150	mΩ
		V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-1.8A		153	186	mΩ
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{GS}$ = $V_{DS}$ , $I_D$ =250uA	-1.2	-1.67	<b>-</b> 2.5	V
gfs	Forward Transconductance	V <sub>DS</sub> =-5V , I <sub>S</sub> =-2.5A		11		S

# Dynamic and switching Characteristics

	<u> </u>			
Qg	Total Gate Charge		 11	
$Q_{gs}$	Gate-Source Charge	V <sub>DS</sub> =-15V , V <sub>GS</sub> =-10V , I <sub>D</sub> =-2A	 2.3	 nC
$Q_gd$	Gate-Drain Charge		 3.0	
$T_{d(on)}$	Turn-On Delay Time		 5.7	
Tr	Rise Time	V <sub>DS</sub> =-15V,I <sub>D</sub> =-2A	 16	 ns
$T_{d(off)}$	Turn-Off Delay Time	V <sub>G</sub> s=-10V,R <sub>G</sub> =3.3Ω	 36	 115
$T_f$	Fall Time		 7	
Ciss	Input Capacitance		 1126	
Coss	Output Capacitance	V <sub>DS</sub> =-15V , V <sub>GS</sub> =0V , F=1MHz	 153	 pF
C <sub>rss</sub>	Reverse Transfer Capacitance		 86	

# Drain-Source Diode Characteristics and Maximum Ratings

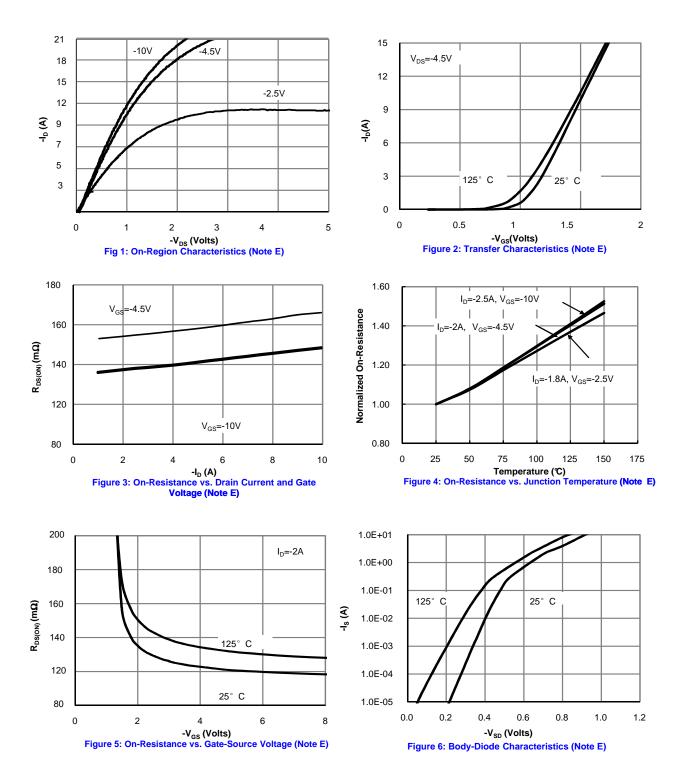
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			-2.5	Α
lsм	Pulsed Source Current				-11	Α
$V_{ extsf{SD}}$	Diode Forward Voltage	V <sub>GS</sub> =0V , I <sub>S</sub> =-1A , T <sub>J</sub> =25℃			-1.2	V

#### Note:

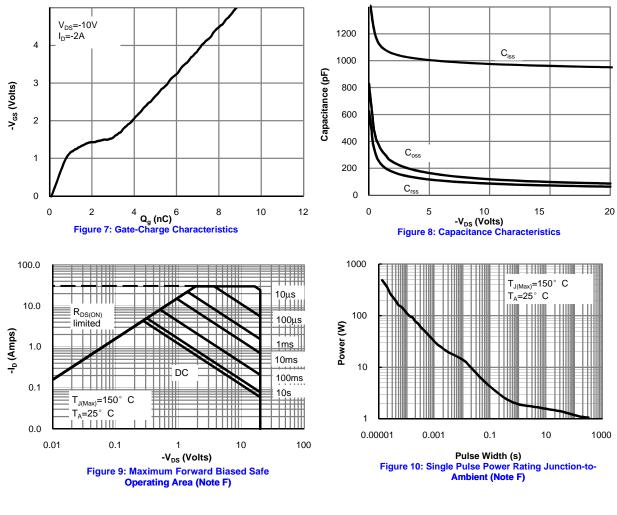
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- **3.** Pulse Test: Pulse Width  $\leq$  300 $\mu$ s, Duty Cycle  $\leq$  2%.
- $\textbf{4.} \ \textbf{Guaranteed by design}, \ \textbf{not subject to production}$

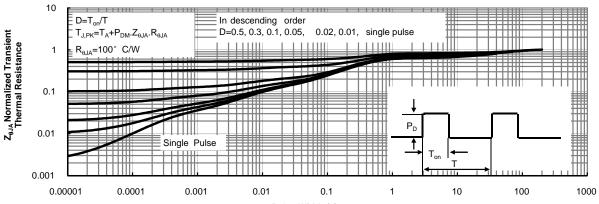


# **Typical Electrical and Thermal Characteristics (Curves)**









Pulse Width (s)
Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)



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